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jc777 U.S. PTO



Sir:

Washington, D.C.

Transmitted herewith for filing is the Patent Application of:

Inventor: ZHI-CHERNG LU, CHI-CHUN CHEN, CHANG WENG

ADJUSTMENT OF N AND K VALUES IN A DARC FILM



Enclosed are:					7
x <u>3</u> sheets	s of drawing(s)	- formal.			
X An assign	nment of the in	nvention to <b>Ta</b>	iwan Semicondu	ctor Manufactu	ring Company
An associ	iate power of a	attorney	Applicant of	claims small e	ntity status
X Request	& Certification	n under 35 USC	2 122(b)(2)(b)(	i)	
The filing fee	has been calcu	ulated as show	n below:		
	(Col. 1)	(Col. 2)	OTHER THAN A	SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE	
BASIC FEE				\$ 740.	
		0.5	8 100		
TOTAL CLAIMS	<b>28</b> -20=	8	x 18 =	\$ 144.	
INDEP CLAIMS	<b>4</b> -3=	11	x 84 =	\$ 84.	
MULTIPLE	DEPENDENT CLA	IM PRESENTED	+ 260 =		
문화 - -		s	UB TOTAL	\$ 968.	
		A	SSIGNMENT	\$40.	
<u> </u>		T	OTAL	\$ 1,008.	
$\overline{\mathbf{X}}$ Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,008. A duplicate					
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X The Comm	issioner is he	reby authorize	ed to charge pa	yment of the f	following fees
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19-0033.	A duplicate	copy of this	sheet is enclos	sed.	
x	Any additional	filing fees	required under	37 CFR §1.16.	
x	Any patent app	lication proce	essing fees und	der 37 CFR <b>§1.</b> 1	.7.
			Respectfully	submitted,	

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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Washington, D.C. 20231. Applicant and/or Attorney requests the date of deposit as the Filing Date.

Date of deposit

Signature / Date

ACKERMAN, REG. NO. 37,761

NONPUBLICATION REQUEST UNDER 35 U.S.C. 122(b)(2)(B)(i)

First Named Inventor		Zhi-Cherng Lu		
Title	Adjustment Of N And K Values In A DARC Film			
Atty Docket Number		TS01-725		

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.

I hereby request that the attached application not be published under 35 U.S.C. 122(b).

2/21/02

Date

Signature

Stephen B. Ackerman, Reg. No. 37,761

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).

Burden Hour Statement: This collection of information is required by 37 CFR 1.213(a). The information is used by the public to request that an application not be published under 35 U.S.C. 122(b) (and the PTO to process that request). Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This form is estimated to take 6 minutes to complete. This time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.